DEVICE SPECIFICATIONS

NI 6320

X Series Data Acquisition: 16 AI, 250 kS/s, 16-Bit Resolution, ±10 V

The following specifications are typical at 25 °C, unless otherwise noted. For more information about the NI 6320, refer to the *X Series User Manual* available at *ni.com/manuals*.

Analog Input

Number of channels	8 differential or 16 single ended
ADC resolution	16 bits
DNL	No missing codes guaranteed
INL	Refer to the *AI Absolute Accuracy* section.
Sample rate	
Single channel maximum	250 kS/s
Multichannel maximum (aggregate)	250 kS/s
Minimum	No minimum
Timing resolution	10 ns
Timing accuracy	50 ppm of sample rate
Input coupling	DC
Input range	±0.2 V, ±1 V, ±5 V, ±10 V
Maximum working voltage for analog inputs (signal + common mode)	±11 V of AI GND
CMRR (DC to 60 Hz)	100 dB
Input impedance	
Device on	
AI+ to AI GND	>10 GΩ in parallel with 100 pF
AI- to AI GND	>10 GΩ in parallel with 100 pF

Device off	
AI+ to AI GND	1,200 Ω
AI- to AI GND	1,200 Ω
Input bias current	±100 pA
Crosstalk (at 100 kHz)	
Adjacent channels	-75 dB
Non-adjacent channels	-90 dB
Small signal bandwidth (-3 dB)	700 kHz
Input FIFO size	4,095 samples
Scan list memory	4,095 entries
Data transfers	DMA (scatter-gather), programmed I/O
Overvoltage protection for all analog input and sense channels	
Device on	±25 V for up to two AI pins
Device off	±15 V for up to two AI pins
Input current during overvoltage condition	±20 mA max/AI pin

Settling Time for Multichannel Measurements

Accuracy, full-scale step, all ranges	
±90 ppm of step (±6 LSB)	4 μs convert interval
±30 ppm of step (±2 LSB)	5 μs convert interval
±15 ppm of step (±1 LSB)	7 μs convert interval

Typical Performance Graph

Figure 1. Settling Error versus Time for Different Source Impedances
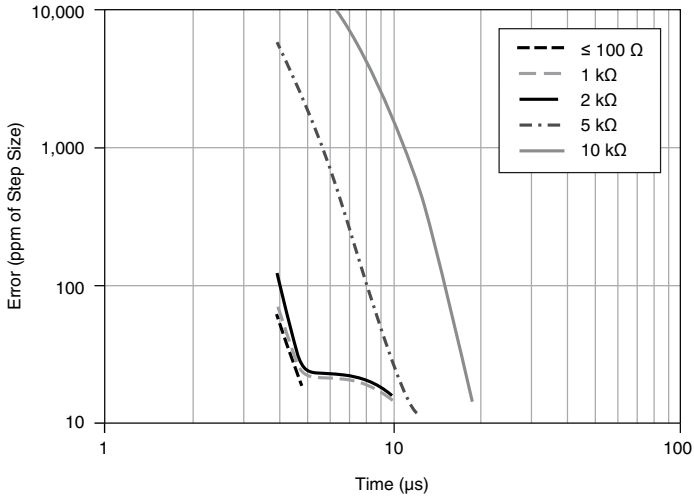
AI Absolute Accuracy

Table 1. AI Absolute Accuracy

Nominal Range Positive Full Scale	Nominal Range Negative Full Scale	Residual Gain Error (ppm of Reading)	Residual Offset Error (ppm of Range)	Offset Tempco (ppm of Range/°C)	Random Noise, σ (µVrms)	Absolute Accuracy at Full Scale (µV)
10	-10	65	13	24	229	2,200
5	-5	72	13	25	118	1,140
1	-1	78	17	37	26	257
0.2	-0.2	105	27	93	12	69

For more information about absolute accuracy at full scale, refer to the *AI Absolute Accuracy Example* section.

Gain tempco	7.3 ppm/°C
Reference tempco	5 ppm/°C
INL error	60 ppm of range

Note Accuracies listed are valid for up to two years from the device external calibration.

AI Absolute Accuracy Equation

AbsoluteAccuracy = Reading · (GainError) + Range · (OffsetError) + NoiseUncertainty

GainError = ResidualGainError + GainTempco · (TempChangeFromLastInternalCal) + ReferenceTempco · (TempChangeFromLastExternalCal)

OffsetError = ResidualOffsetError + OffsetTempco · (TempChangeFromLastInternalCal) + INLError

$NoiseUncertainty = \dfrac{\text{Random Noise} \cdot 3}{\sqrt{10,000}}$ for a coverage factor of 3 σ and averaging 10,000 points.

AI Absolute Accuracy Example

Absolute accuracy at full scale on the analog input channels is determined using the following assumptions:

- *TempChangeFromLastExternalCal* = 10 °C
- *TempChangeFromLastInternalCal* = 1 °C
- *number_of_readings* = 10,000
- *Coveragefactor* = 3 σ

For example, on the 10 V range, the absolute accuracy at full scale is as follows:

GainError = 65 ppm + 7.3 ppm · 1 + 5 ppm · 10 = 122 ppm

OffsetError = 13 ppm + 24 ppm · 1 + 60 ppm = 97 ppm

$NoiseUncertainity = \dfrac{229\ \mu V \cdot 3}{\sqrt{10,000}} = 6.9\ \mu V$

AbsoluteAccuracy = 10 V · (*GainError*) + 10 V · (*OffsetError*) + *NoiseUncertainity* = 2,220 µV

Digital I/O/PFI

Static Characteristics

Number of channels	24 total, 8 (P0.<0..7>), 16 (PFI <0..7>/P1, PFI <8..15>/P2)
Ground reference	D GND
Direction control	Each terminal individually programmable as input or output
Pull-down resistor	50 kΩ typical, 20 kΩ minimum
Input voltage protection	±20 V on up to two pins

⚠️ **Caution** Stresses beyond those listed under the *Input voltage protection* specification may cause permanent damage to the device.

Waveform Characteristics (Port 0 Only)

Terminals used	Port 0 (P0.<0..7>)
Port/sample size	Up to 8 bits
Waveform generation (DO) FIFO	2,047 samples
Waveform acquisition (DI) FIFO	255 samples
DO or DI Sample Clock frequency	0 to 1 MHz, system and bus activity dependent
Data transfers	DMA (scatter-gather), programmed I/O
Digital line filter settings	160 ns, 10.24 μs, 5.12 ms, disable

PFI/Port 1/Port 2 Functionality

Functionality	Static digital input, static digital output, timing input, timing output
Timing output sources	Many AI, AO, counter, DI, DO timing signals
Debounce filter settings	90 ns, 5.12 μs, 2.56 ms, custom interval, disable; programmable high and low transitions; selectable per input

Recommended Operating Conditions

Input high voltage (V_{IH})	
Minimum	2.2 V
Maximum	5.25 V

Input low voltage (V_{IL})

Minimum	0 V
Maximum	0.8 V

Output high current (I_{OH})

P0.<0..7>	-24 mA maximum
PFI <0..15>/P1/P2	-16 mA maximum

Output low current (I_{OL})

P0.<0..7>	24 mA maximum
PFI <0..15>/P1/P2	16 mA maximum

Digital I/O Characteristics

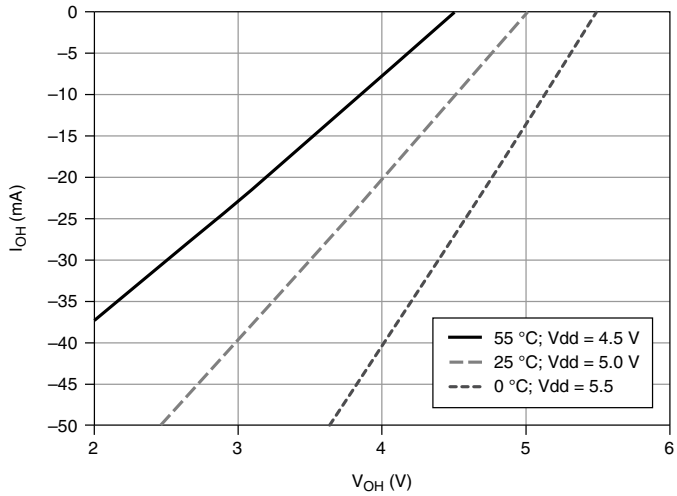|	
Positive-going threshold (VT+)	2.2 V maximum
Negative-going threshold (VT-)	0.8 V minimum
Delta VT hysteresis (VT+ - VT-)	0.2 V minimum
I_{IL} input low current (V_{IN} = 0 V)	-10 μA maximum
I_{IH} input high current (V_{IN} = 5 V)	250 μA maximum

Figure 2. P0.<0..7>: I_{OH} versus V_{OH}
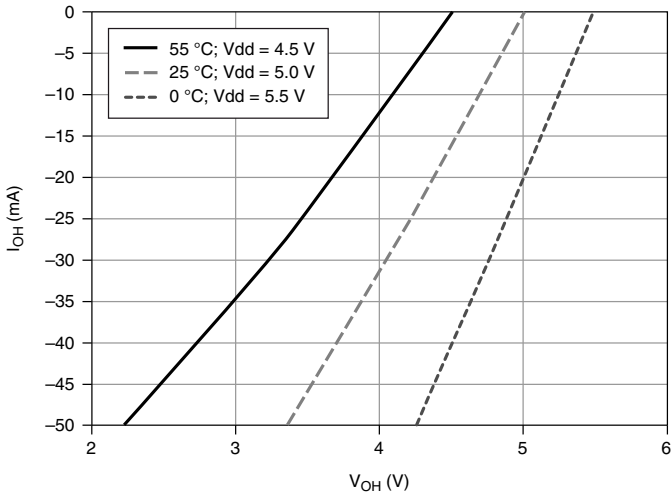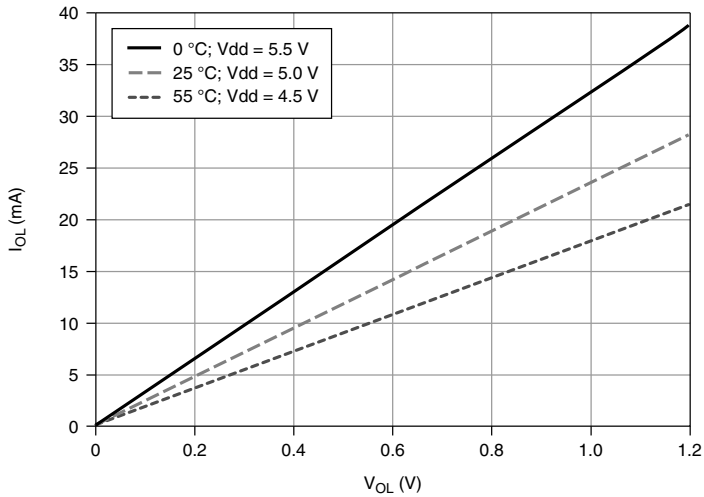
Figure 3. P0.<0..7>: I_{OL} versus V_{OL}
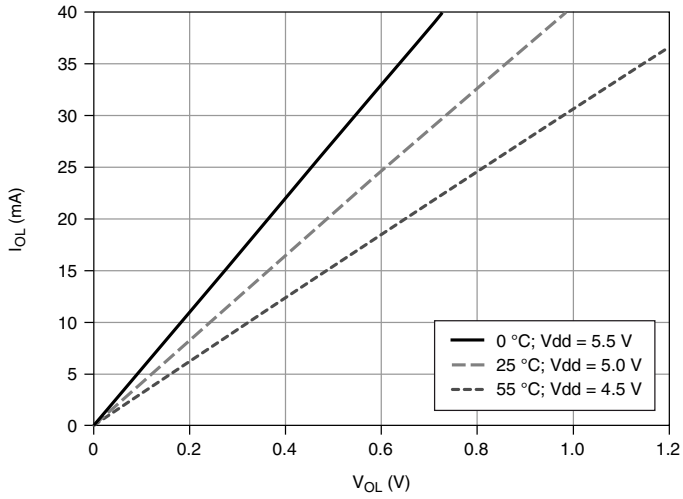
Figure 4. PFI <0..15>/P1/P2: I_{OH} versus V_{OH}

Figure 5. PFI <0..15>/P1/P2: I_{OL} versus V_{OL}

General-Purpose Counters

Number of counter/timers	4
Resolution	32 bits
Counter measurements	Edge counting, pulse, pulse width, semi-period, period, two-edge separation
Position measurements	X1, X2, X4 quadrature encoding with Channel Z reloading; two-pulse encoding
Output applications	Pulse, pulse train with dynamic updates, frequency division, equivalent time sampling
Internal base clocks	100 MHz, 20 MHz, 100 kHz
External base clock frequency	0 to 25 MHz
Base clock accuracy	50 ppm
Inputs	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down, Sample Clock
Routing options for inputs	Any PFI, RTSI, many internal signals
FIFO	127 samples per counter
Data transfers	Dedicated scatter-gather DMA controller for each counter/timer, programmed I/O

Frequency Generator

Number of channels	1
Base clocks	20 MHz, 10 MHz, 100 kHz
Divisors	1 to 16
Base clock accuracy	50 ppm

Output can be available on any PFI or RTSI terminal.

Phased-Locked Loop (PLL)

Number of PLLs	1

Table 2. Reference Clock Locking Frequencies

Reference Signal	Locking Input Frequency (MHz)
RTSI <0..7>	10, 20
PFI <0..15>	10, 20

Output of PLL	100 MHz Timebase; other signals derived from 100 MHz Timebase including 20 MHz and 100 kHz Timebases

External Digital Triggers

Source	Any PFI, RTSI
Polarity	Software-selectable for most signals
Analog input function	Start Trigger, Reference Trigger, Pause Trigger, Sample Clock, Convert Clock, Sample Clock Timebase
Analog output function	Start Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase
Counter/timer functions	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down, Sample Clock

Digital waveform generation (DO) function	Start Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase
Digital waveform acquisition (DI) function	Start Trigger, Reference Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase

Device-to-Device Trigger Bus

Input source	RTSI <0..7>
Output destination	RTSI <0..7>
Output selections	10 MHz Clock, frequency generator output, many internal signals
Debounce filter settings	90 ns, 5.12 μs, 2.56 ms, custom interval, disable; programmable high and low transitions; selectable per input

Bus Interface

Form factor	x1 PCI Express, specification v1.1 compliant
Slot compatibility	x1, x4, x8, and x16 PCI Express slots[1]
DMA channels	8, can be used for analog input, analog output, digital input, digital output, counter/timer 0, counter/timer 1, counter/timer 2, counter/timer 3

Power Requirements

⚠ **Caution** The protection provided by the device can be impaired if the device is used in a manner not described in the *X Series User Manual.*

Without disk drive power connector installed

+3.3 V	1.4 W
+12 V	8.6 W

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[1] Some motherboards reserve the x16 slot for graphics use. For PCI Express guidelines, refer to *ni.com/pciexpress*.

With disk drive power connector installed

+3.3 V	1.4 W
+12 V	3 W
+5 V	15 W

Current Limits

⚠️ **Caution** Exceeding the current limits may cause unpredictable behavior by the device and/or PC.

Without disk drive power connector installed

P0/PFI/P1/P2 and +5 V terminals combined	1 A max

With disk drive power connector installed

+5 V terminal (connector 0)	1 A max[2]
+5 V terminal (connector 1)	1 A max[2]
P0/PFI/P1/P2 combined	1 A max

Physical Characteristics

Printed circuit board dimensions	9.9 × 16.8 cm (3.9 × 6.6 in.) (half-length)
Weight	104 g (3.6 oz)
I/O connector	1 68-pin VHDCI

Table 3. Mating Connectors

Manufacturer, Part Number	Description
MOLEX 71430-0011	68-Pos Right Angle Single Stack PCB-Mount VHDCI (Receptacle)
MOLEX 74337-0016	68-Pos Right Angle Dual Stack PCB-Mount VHDCI (Receptacle)
MOLEX 71425-3001	68-Pos Offset IDC Cable Connector (Plug) (SHC68-*)

Disk drive power connector	Standard ATX peripheral connector (not serial ATA)

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[2] Has self-resetting fuse that opens when current exceeds this specification.

Calibration

Recommended warm-up time	15 minutes
Calibration interval	2 years

Maximum Working Voltage

Maximum working voltage refers to the signal voltage plus the common-mode voltage.

⚠️ **Caution** The protection provided by the DAQ device can be impaired if it is used in a manner not described in the *X Series User Manual*.

Channel to earth	11 V, Measurement Category I

📝 **Note** Measurement Categories CAT I and CAT O (Other) are equivalent. These test and measurement circuits are not intended for direct connection to the MAINs building installations of Measurement Categories CAT II, CAT III, or CAT IV.

Environmental

Operating temperature	0 to 50 °C
Storage temperature	-40 to 70 ºC
Operating humidity	10 to 90% RH, noncondensing
Storage humidity	5 to 95% RH, noncondensing
Pollution Degree	2
Maximum altitude	2,000 m

Indoor use only.

Safety

This product meets the requirements of the following standards of safety for electrical equipment for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA 61010-1

📝 **Note** For UL and other safety certifications, refer to the product label or the *Online Product Certification* section.

Electromagnetic Compatibility

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326-1 (IEC 61326-1): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions
- AS/NZS CISPR 11: Group 1, Class A emissions
- FCC 47 CFR Part 15B: Class A emissions
- ICES-001: Class A emissions

Note In the United States (per FCC 47 CFR), Class A equipment is intended for use in commercial, light-industrial, and heavy-industrial locations. In Europe, Canada, Australia, and New Zealand (per CISPR 11) Class A equipment is intended for use only in heavy-industrial locations.

Note Group 1 equipment (per CISPR 11) is any industrial, scientific, or medical equipment that does not intentionally generate radio frequency energy for the treatment of material or inspection/analysis purposes.

Note For EMC declarations and certifications, refer to the *Online Product Certification* section.

CE Compliance $C \in$

This product meets the essential requirements of applicable European Directives, as follows:

- 2006/95/EC; Low-Voltage Directive (safety)
- 2014/30/EU; Electromagnetic Compatibility Directive (EMC)

Online Product Certification

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for this product, visit *ni.com/ certification*, search by model number or product line, and click the appropriate link in the Certification column.

Environmental Management

NI is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial to the environment and to NI customers.

For additional environmental information, refer to the *Minimize Our Environmental Impact* web page at *ni.com/environment*. This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

Waste Electrical and Electronic Equipment (WEEE)

EU Customers At the end of the product life cycle, all NI products must be disposed of according to local laws and regulations. For more information about how to recycle NI products in your region, visit *ni.com/environment/weee*.
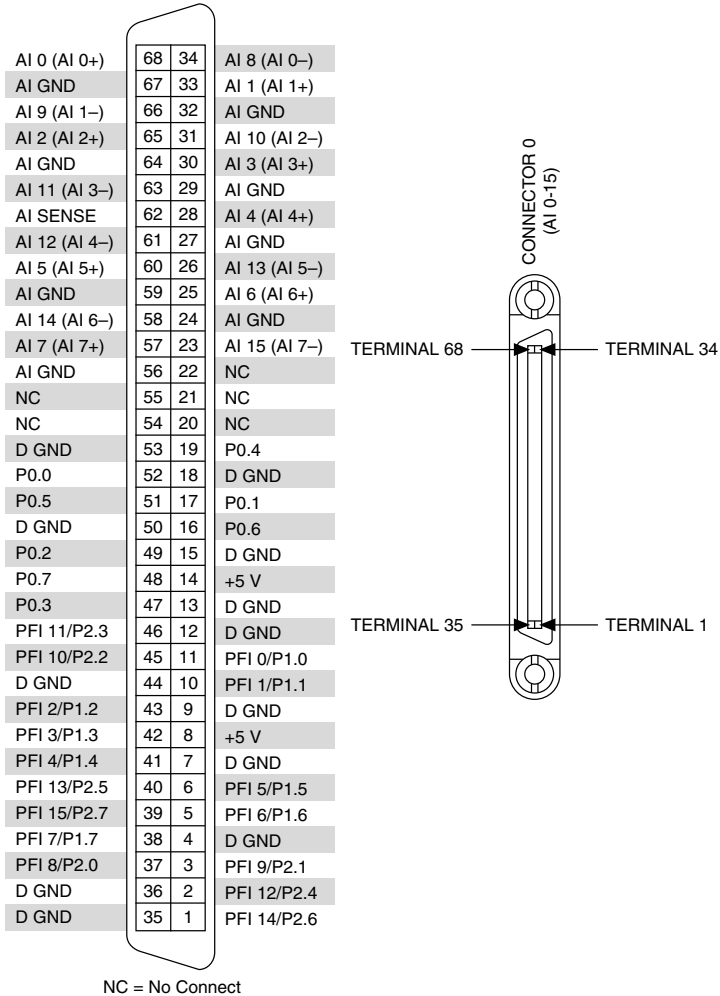
电子信息产品污染控制管理办法（中国 **RoHS**）

中国客户 National Instruments 符合中国电子信息产品中限制使用某些有害物质指令(RoHS)。关于 National Instruments 中国 RoHS 合规性信息，请登录 ni.com/environment/rohs_china。（For information about China RoHS compliance, go to ni.com/environment/rohs_china.）

Device Pinout

Figure 6. NI PCIe-6320 Pinout

AI 0 (AI 0+)	68	34	AI 8 (AI 0–)
AI GND	67	33	AI 1 (AI 1+)
AI 9 (AI 1–)	66	32	AI GND
AI 2 (AI 2+)	65	31	AI 10 (AI 2–)
AI GND	64	30	AI 3 (AI 3+)
AI 11 (AI 3–)	63	29	AI GND
AI SENSE	62	28	AI 4 (AI 4+)
AI 12 (AI 4–)	61	27	AI GND
AI 5 (AI 5+)	60	26	AI 13 (AI 5–)
AI GND	59	25	AI 6 (AI 6+)
AI 14 (AI 6–)	58	24	AI GND
AI 7 (AI 7+)	57	23	AI 15 (AI 7–)
AI GND	56	22	NC
NC	55	21	NC
NC	54	20	NC
D GND	53	19	P0.4
P0.0	52	18	D GND
P0.5	51	17	P0.1
D GND	50	16	P0.6
P0.2	49	15	D GND
P0.7	48	14	+5 V
P0.3	47	13	D GND
PFI 11/P2.3	46	12	D GND
PFI 10/P2.2	45	11	PFI 0/P1.0
D GND	44	10	PFI 1/P1.1
PFI 2/P1.2	43	9	D GND
PFI 3/P1.3	42	8	+5 V
PFI 4/P1.4	41	7	D GND
PFI 13/P2.5	40	6	PFI 5/P1.5
PFI 15/P2.7	39	5	PFI 6/P1.6
PFI 7/P1.7	38	4	D GND
PFI 8/P2.0	37	3	PFI 9/P2.1
D GND	36	2	PFI 12/P2.4
D GND	35	1	PFI 14/P2.6

NC = No Connect

CONNECTOR 0
(AI 0-15)

TERMINAL 68 — TERMINAL 34

TERMINAL 35 — TERMINAL 1